

Features

- Epitaxial Planar Die Construction
- Built-In Biasing Resistors
- Surface Mount Package Suited for Automated Assembly
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen- and Antimony-Free. “Green” Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High-Reliability**
- **PPAP Capable (Note 4)**

R ₁ (NOM)	R ₂ (NOM)
1kΩ	10kΩ

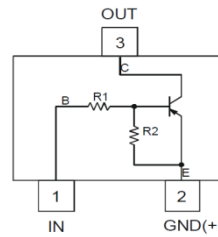
SOT323



Top View

Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, “Green” Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.006 grams (Approximate)



Device Schematic

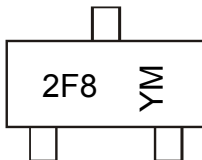
Ordering Information (Note 5)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
ADTA113ZUAQ-7	Automotive	2F8	7	8	3,000
ADTA113ZUAQ-13	Automotive	2F8	13	8	10,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to <https://www.diodes.com/quality/>.
 5. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information

SOT323



2F8 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: F = 2018)
 M = Month (ex: 9 = September)

Date Code Key

Year	2018	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028
Code	F	G	H	I	J	K	L	M	N	O	P

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

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Absolute Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage <Pin: (3) to (2)>	V_{CC}	-50	V
Input Voltage <Pin: (1) to (2)>	V_{IN}	-10 to 5	V
Output Current	I_O	-100	mA
Output Current	I_C (Max)	-100	mA

Thermal Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

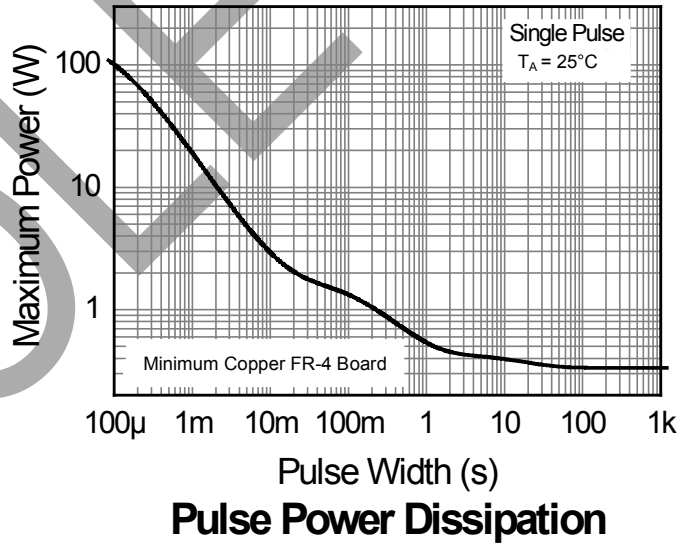
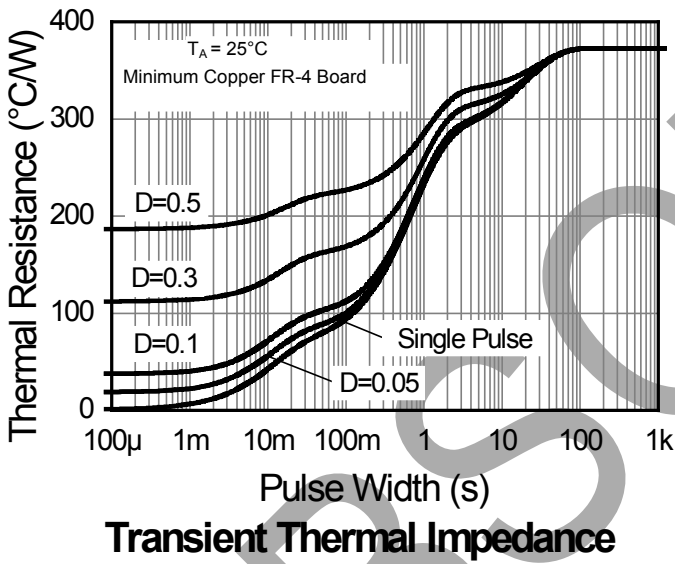
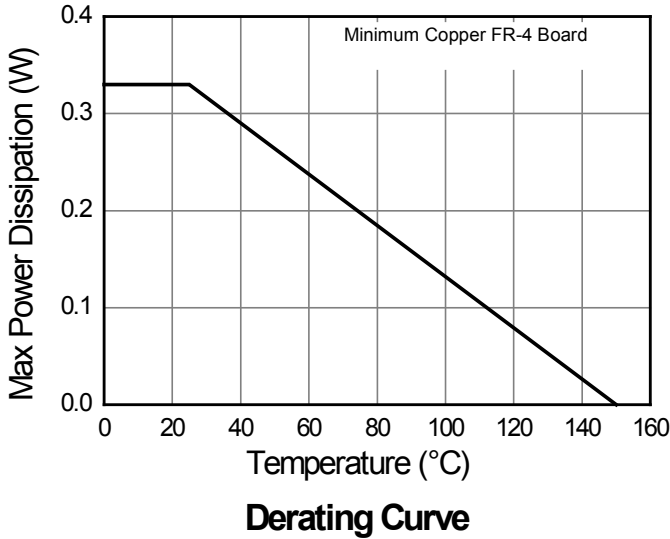
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_D	330	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{\theta JA}$	375	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Note: 6. Mounted on FR-4 PC Board with minimum recommended pad layout.

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Thermal Characteristics and Derating Information



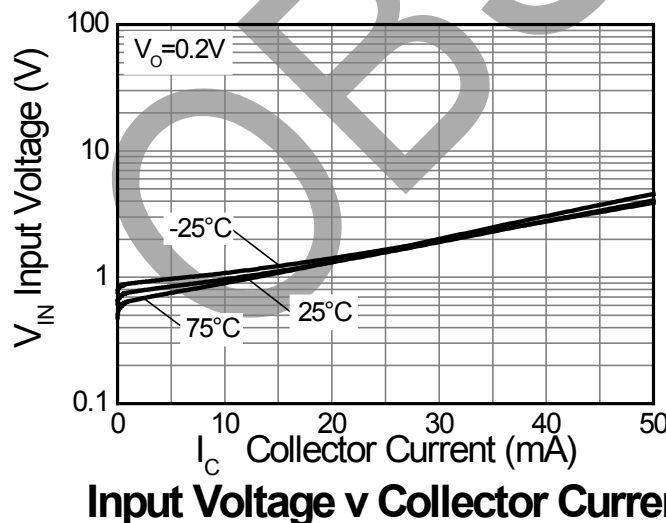
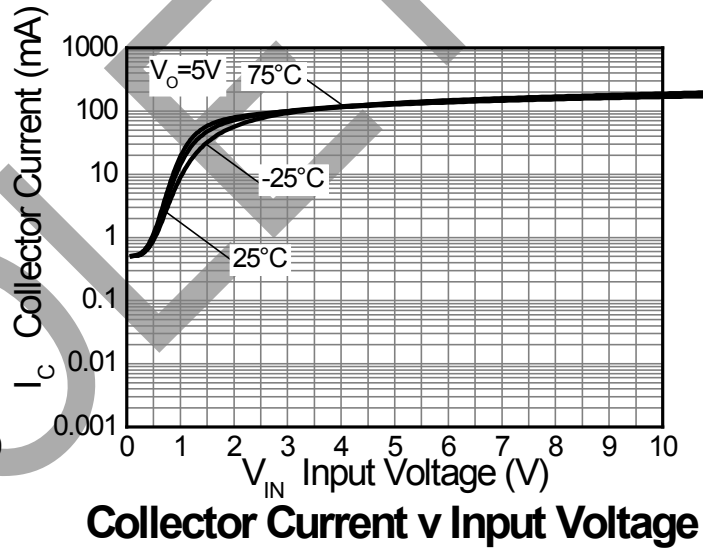
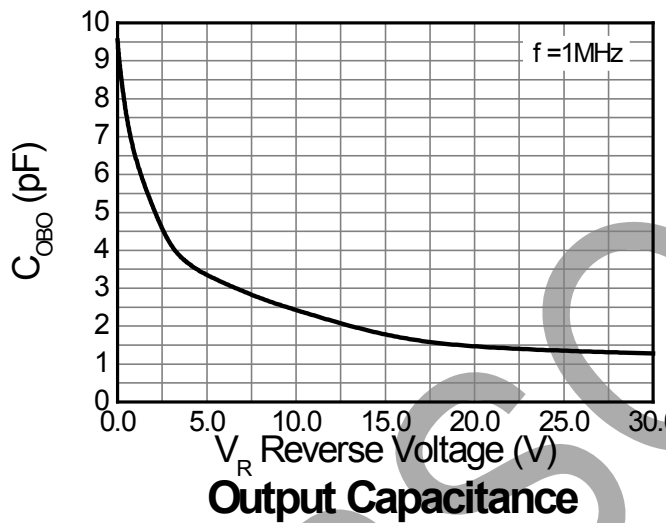
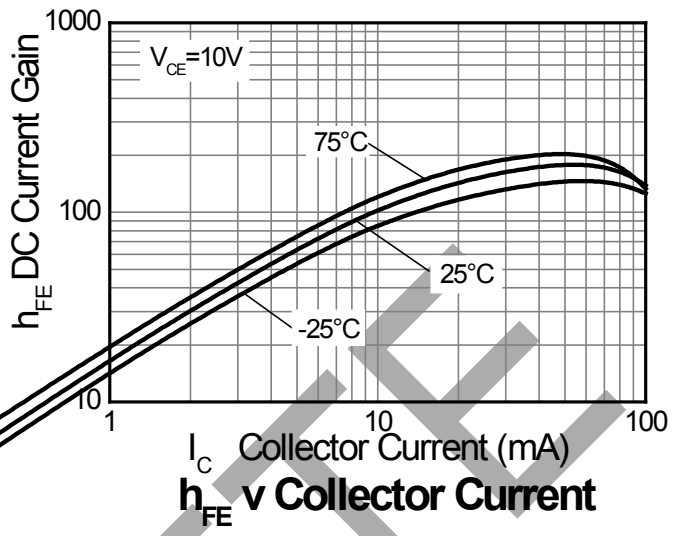
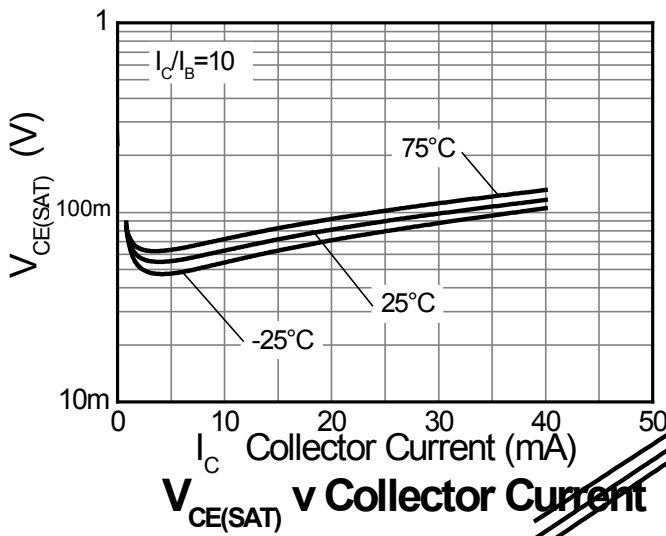
Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Input Voltage	$V_{I(OFF)}$ (Note 7)	-0.3	—	—	V	$V_{CC} = -5\text{V}$, $I_O = -100\mu\text{A}$
	$V_{I(ON)}$ (Note 8)	—	—	-3.0		$V_O = -0.3\text{V}$, $I_O = -20\text{mA}$
Output Voltage	$V_{O(ON)}$	—	-0.1	-0.3	V	$I_O/I_I = -10\text{mA} / -0.5\text{mA}$
Input Current	I_I	—	—	-7.2	mA	$V_I = -5\text{V}$
Output Current	$I_{O(OFF)}$	—	—	-0.5	μA	$V_{CC} = -50\text{V}$, $V_I = 0\text{V}$
DC Current Gain	G_I	33	—	—	—	$V_O = -5\text{V}$, $I_O = -10\text{mA}$
Input Resistor (R_1) Tolerance	ΔR_1	-30	—	30	%	—
Resistance Ratio Tolerance	$\Delta R_2/R_1$	-20	—	20	%	—
Gain-Bandwidth Product (Note 9)	f_T	—	250	—	MHz	$V_{CE} = -10\text{V}$, $I_E = -5\text{mA}$, $f = 100\text{MHz}$

- Notes:
7. Guarantees that the device will be switched OFF if the Input Voltage is less than -0.3V.
 8. Guarantees that the device will be switched ON if the Input Voltage is more than -3V.
 9. Transistor - For Reference Only.

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Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

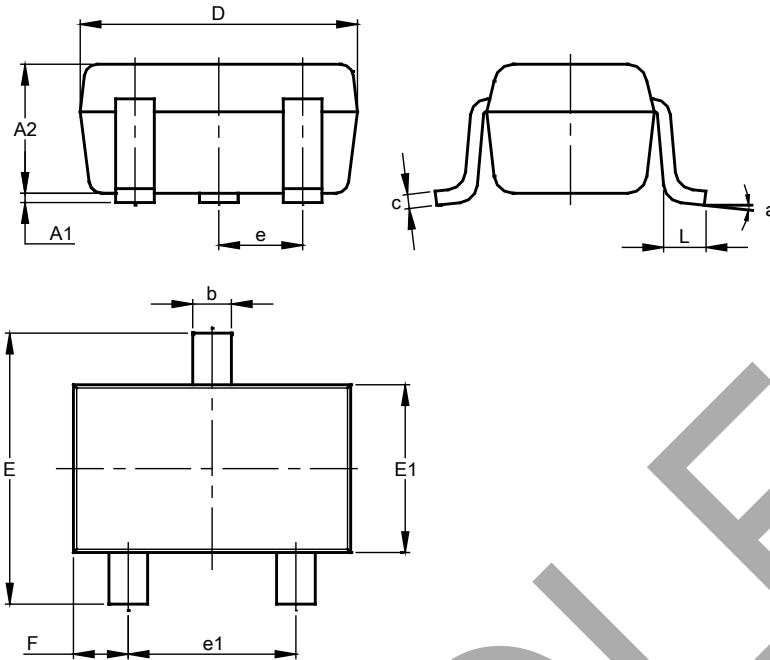


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Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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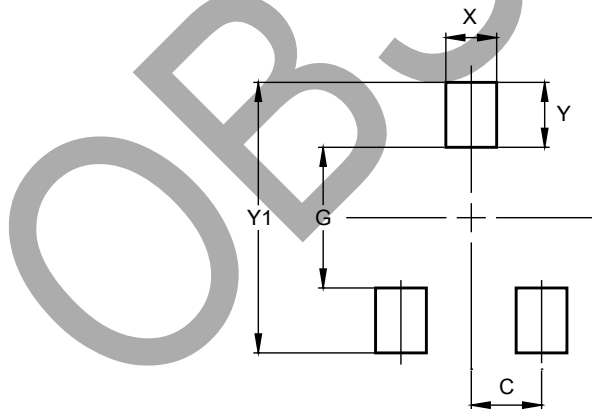


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Dim	Min	Max	Typ
A1	0.00	0.10	0.05
A2	0.90	1.00	0.95
b	0.25	0.40	0.30
c	0.10	0.18	0.11
D	1.80	2.20	2.15
E	2.00	2.20	2.10
E1	1.15	1.35	1.30
e	0.650 BSC		
e1	1.20	1.40	1.30
F	0.375	0.475	0.425
L	0.25	0.40	0.30
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT323



Dimensions	Value (in mm)
C	0.650
G	1.300
X	0.470
Y	0.600
Y1	2.500

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